Surface Mount Red LED 1.6mm × 0.8mm





Features

- 1.6mm × 0.8mm SMT LED, 0.7mm Thickness
- · Wide Viewing Angle
- · Ideal for Backlight and Indicator

RoHS Compliant

Applications

- · Automotive: backlighting in dashboard and switch
- · Telecommunication: indicator and backlighting in telephone and fax
- Flat backlight for LCD switch and symbol

Device Selection

С	Lens Colour			
Material	Emitted Colour	Lens Colour		
InGaAIP	Red	Water Clear		

Absolute Maximum Ratings at TA = 25°C

Parameter	Symbol	Values	Unit
Power Dissipation	PD	65	mW
Forward Current	lF	25	mA
Peak Forward Current*	lfp	100	mA
Reverse Voltage	VR	5	V
Operating Temperature	Topr	-40 to +85	°C
Storage Temperature	Tstg	-40 to +85	°C

Note:

Electrical / Optical Characteristics at TA = 25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Forward Voltage	VF	1.8	-	2.5	V	IF = 20mA
Reverse Current	lr	-	-	10	μA	V _R =5V
Dominate Wavelength	λD	617	-	629	nm	IF = 20mA
Luminous Intensity	lv	170	-	385	mcd	IF = 20mA
Viewing Angle	201/2	-	120	-	Deg.	IF = 20mA

Remarks

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or chromaticity), the typical accuracy of the sorting process is as follows:

1. Wavelength: ±1nm

2. Luminous Intensity: ±15%3. Forward Voltage: ±0.1V

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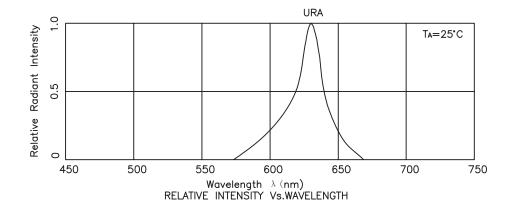


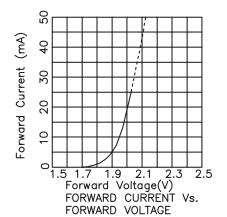
^{*}Pulse width ≤0.1ms, Duty cycle ≤1/10

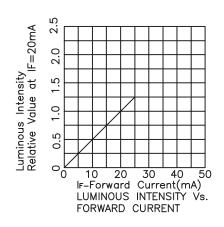
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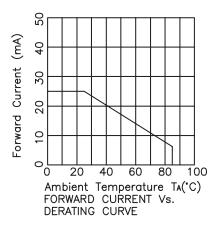
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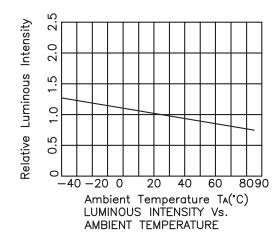
Typical Electrical / Optical Characteristics Curves

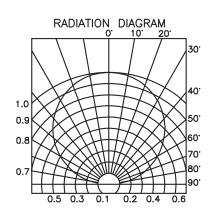












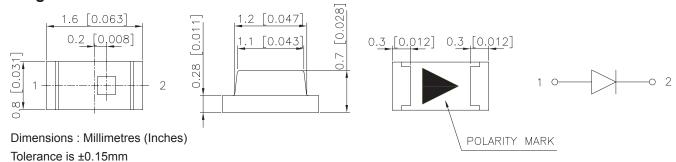
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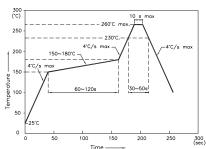


Diagram



Soldering Profile

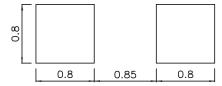
Reflow Soldering Profile For Lead-free SMT Process.



Notes

- 1. We recommend the reflow temperature 245°C. (±5°C) The maximum soldering temperature should be limited to 260°C.
- 2. Don't cause stress to epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

Recommended soldering pattern



Dimensions: Millimetres

Part Number Table

Description	Part Number
Surface Mount LED, Red, 2.5V, 385 mcd, 629nm	MP001249

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